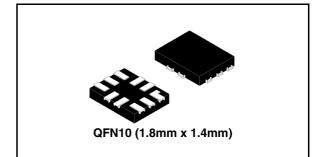


STG3682

Low voltage high bandwidth dual SPDT switch

Features

- Ultra low power dissipation:
 - I_{CC} = 0.2µA (Max.) at T_A = 85°C
- Low "ON" resistance:
 - R_{ON} = 4.6 Ω (T_A = 25°C) at V_{CC} = 4.3V
 - $R_{ON} = 5.8\Omega (T_A = 25^{\circ}C)$ at $V_{CC} = 3.0V$
- Wide operating voltage range:
 - V_{CC} (Opr) = 1.65V to 4.3V single supply
- 4.3V tolerant and 1.8V compatible threshold on digital control input at V_{CC} = 2.3V to 3.0V
- Typical bandwidth (-3dB) at 800MHz on all channels
- Latch-up performance exceeds 100mA per JESD 78, Class II
- ESD performance exceeds JESD22
 2000-V Human body model (A114-A)
- USB (2.0) High speed (480Mbps) signal switching compliant



Description

The STG3682 is a high-speed CMOS low voltage dual analog S.P.D.T. (Single Pole Dual Throw) Switch or 2:1 Multiplexer /Demultiplexer Switch fabricated in silicon gate C²MOS technology. It is designed to operate from 1.65V to 4.3V, making this device ideal for portable applications.

The nSEL inputs are provided to control the switch. The switch S1 is ON (they are connected to common Ports Dn) when the nSEL input is held high and OFF (high impedance state exists between the two ports) when SEL is held low; the switch S2 is ON (it is connected to common Port D) when the nSEL input is held low and OFF (high impedance state exists between the two ports) when nSEL is held high.

Additional key features are fast switching speed, Break Before Make Delay Time and Ultra Low Power Consumption. All inputs and outputs are equipped with protection circuits against static discharge, giving them ESD immunity and transient excess voltage.

Order codes

Part number	Package	Packaging
STG3682QTR	QFN10 (1.8mm x 1.4mm)	Tape and reel

Contents

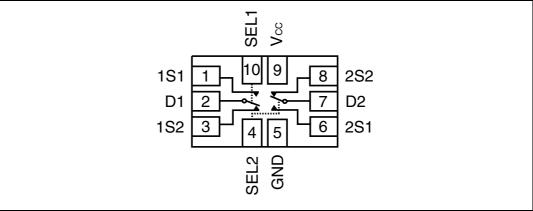
1	Pin settings
	1.1 Pin connection
	1.2 Pin description
2	Device summary
3	Maximum rating
	3.1 Recommended operating conditions 5
4	Electrical characteristics
5	Test circuits
6	Package mechanical data 13
7	Revision history



1 Pin settings

1.1 Pin connection

Figure 1. Pin connection (top through view)



1.2 Pin description

Table 1. Pin description

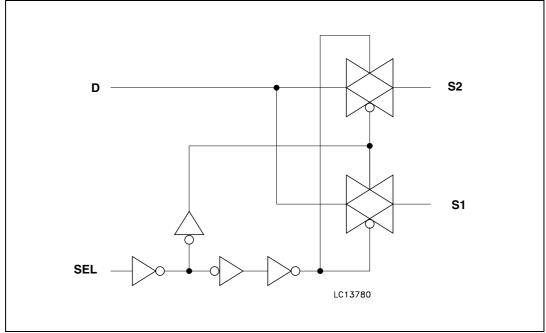
Pin N°	Symbol	Name and function
1,3,6,8	1S1, 1S2, 2S1, 2S2	Independent channels
2,7	D1,D2	Common channels
10,4	SEL1,SEL2	Control
9	VCC	Possitive supply voltage
5	GND	Ground (0V)

Note:

Exposed pad must be soldered to a floating plane. Do NOT connect to power or ground.



2 Device summary



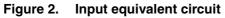


Table 2. Truth table

SEL	Switch S1	Switch S2
Н	ON	OFF ⁽¹⁾
L	OFF ⁽¹⁾	ON

1. High Impedance



3 Maximum rating

Stressing the device above the rating listed in the "Absolute Maximum Ratings" table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage	-0.5 to 5.5	V
VI	DC input voltage	-0.5 to V _{CC} + 0.5	V
V _{IC}	DC control input voltage	-0.5 to 5.5	V
V _O	DC output voltage	-0.5 to V _{CC} + 0.5	V
I _{IKC}	DC input diode current on control pin (V _{SEL} <0V)	-50	mA
Ι _{ΙΚ}	DC input diode current (V _{SEL} <0V)	±50	mA
I _{OK}	DC output diode current	±20	mA
Ι _Ο	DC output current	±128	mA
I _{OP}	DC output current peak (pulse at 1ms, 10% duty cycle)	±300	mA
I _{CC} or I _{GND}	DC V _{CC} or ground current	±100	mA
P_D	Power dissipation at $T_A = 70^{\circ}C^{(1)}$	1120	mW
T _{stg}	Storage temperature	-65 to 150	°C
ΤL	Lead temperature (10 sec)	300	°C

1. Derate above 70°C by 18.5mW/C

3.1 Recommended operating conditions

Table 4. Recommended operating conditions

Symbol	Paramete	Value	Unit		
V _{CC}	Supply voltage ⁽¹⁾	1.65 to 4.3	V		
VI	Input voltage	0 to V _{CC}	V		
V _{IC}	Control input voltage	0 to 4.3	V		
Vo	Output voltage	0 to V _{CC}	V		
T _{op}	Operating temperature		-40 to 85	°C	
dt/dv	Input rise and fall time control	V _{CC} = 1.65V to 2.7V	0 to 20	nc/V	
uvuv	input	V _{CC} = 3.0 to 4.3V	0 to 10	ns/V	

1. Truth Table guaranteed: 1.2V to 4.3V



4 Electrical characteristics

Table 5. DC specifications

		Tes	t conditions						
Symbol	Parameter			Τ ₄	_ = 25°C	;	-40 to	85°C	Unit
		Vcc (V)		Min	Тур	Max	Min	Мах	
		1.65 -1.95		0.65V _{CC}			$0.65V_{CC}$		
		2.3-2.5		1.2			1.2		
V _{IH}	High level input voltage	2.7-3.0		1.3			1.3		V
	pat renage	3.3-3.6		1.4			1.4		
		4.3		1.6			1.6		
		1.65-1.95				0.25			
		2.3-2.5				0.25			
V _{IL}	Low level input voltage	2.7-3.0				0.25			V
	input voltage	3.3-3.6				0.30			
		4.3				0.40			
	Switch ON peak resistance	1.8			12.0	16.0			
R _{PEAK}		2.7	$V_{S} = 0V$ to V_{CC} $I_{S} = 8mA$		6.3	8.0			
		3.0			5.8	7.5			Ω
		3.7			5.0	6.5			
		4.3			4.6	6.0			
Bau	Switch On	3.0	$V_S = 3V I_S = 8mA$		4.0	5.2			0
R _{ON}	resistance	3.0	$V_{\rm S} = 0.8 V I_{\rm S} = 8 m A$		5.0	6.5			52
	ON	1.8							
	resistance	2.7							
ΔR_{ON}	match	3.0	- V _S @ R _{ON} Max I _S = 8mA		0.3				Ω
	between channels ⁽¹⁾	3.7							
		4.3							
		1.8			6.6				
	ON	2.7	$V_{\rm S} = 0V$ to $V_{\rm CC}$		2.0				
R _{FLAT}	resistance	3.0	$I_S = 8mA$		1.7				Ω
	flatness ⁽²⁾	3.7			1.5				
		4.3			1.6				1
I _{OFF}	OFF state leakage current (SN), (D)	4.3	V _S = 0.3 or 4V			±20		±100	nA

Symbol		Test conditions								
	Parameter			T,	_A = 25°C	;	-40 to	85°C	Unit	
		Vcc (V)		Min	Тур	Max	Min	85°C Max ±1 ±1.0 ±100		
I _{IN}	Input leakage current	0 to 4.3	V _{SEL} = 0 to 4.3V			±0.1		±1	μA	
I _{CC}	Quiescent supply current	1.65 to 4.3	$V_{SEL} = V_{CC}$ or GND			±0.1		±1.0	μA	
	Quiescent			V _{1-2SEL,} V _{3-4SEL} = 1.65V		±37	±50		±100	
I _{CCLV}	supply current low voltage	4.3	V _{1-2SEL,} V _{3-4SEL} = 1.80V		±33	±40		±50	μA	
	driving		V _{1-2SEL,} V _{3-4SEL} = 2.60V		±11	±20		±30		

Table 5. DC specifications

1. Note 1: $\Delta Ron = max |mSN-nSN|$, where m = 1..4 and n = 1..4, N = 1..2

2. Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.



		Test co	onditions		Value					
Symbol	Parameter	Vcc (V)			T _A = 25°C		-40 to	o 85°C	Unit	
		VCC (V)		Min	Тур	Max	Min	Max		
		1.65-1.95			0.30					
tour tour	Propagation	2.3-2.7			0.30				ns	
t _{PLH} , t _{PHL}	delay	3.0-3.3			0.25				115	
		3.6-4.3			0.25					
		1.65-1.95	$V_{\rm S} = 0.8 V$		31					
tev	Turn-ON	2.3-2.7			20	26		34		
t _{ON}	time	3.0-3.3	V _S = 1.5V		15	20		26	ns	
		3.6-4.3			12	15		20		
		1.65-1.95	V _S = 0.8		22				ns	
tarr	Turn-OFF	2.3-2.7			14	18		23		
t _{OFF}	time	3.0-3.3	V _S = 1.5V		11	14		18	115	
		3.6-4.3			10	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$				
		1.65-1.95	0 05-5	1	7					
t _D	Break before make	2.3-2.7	C _L = 35pF R _L = 50Ω	1	5				ns	
чD	time delay	3.0-3.3	$V_{\rm S} = 1.5V$	1	4				115	
		3.6-4.3		1	3					
		1.65	0 100=5		2.8					
Q	Charge	2.3	C _L = 100pF V _{GEN} = 0V		3.5				pC	
	injection	3.0	$R_{GEN} = 00$		3.8					
		4.3			5.0					

Table 6. AC electrical characteristics ($C_L = 35pF$, $R_L = 50\Omega$, $t_r = t_f \leq 5ns$)



		Test Conditions							
Symbol	Parameter	Vcc (V)		T _A = 25°C			-40 to 85°C		Unit
		VCC (V)		Min	Тур	Max	Min	Мах	
OIRR	OFE loolation ⁽¹⁾	1.65 - 4.3	V _S = 1V _{RMS,} f = 1MHz Signal = 0 dBm		-79				dB
UINN	OFF Isolation ⁽¹⁾	1.03 - 4.0	$V_{S} = 1V_{RMS}$, f = 10MHz Signal = 0 dBm		-60				UD .
Xtalk Crosstalk	ılk Crosstalk	1.65 - 4.3	V _S = 1V _{RMS,} f = 1MHz Signal = 0 dBm		-78				dB
Λιαικ		1.05 - 4.5	$V_S = 1V_{RMS,} f = 10MHz$ Signal = 0 dBm		-61				UD .
BW	-3dB bandwidth	3.0 - 4.3	R _L = 50Ω Signal = 0dBm		800				MHz
D _G	Differential gain	3.0 - 4.3	RL = 150Ω		0.64				%
D _P	Differential phase	3.0 - 4.3	RL = 150Ω		0.1				deg
C _{IN}	Control pin input capacitance		$V_{CC} = 0V$		6.2				
C _{ON}	Sn Port capacitance when switch is enabled	3.3	f = 1MHz		22				pF
C _{OFF}	Sn Port capacitance when switch is disabled	3.3	f = 1MHz		21				

Table 7. Analog switch characteristics (C $_L$ = 5pF, R $_L$ = 50 Ω T $_A$ = 25 $^\circ C$)

1. Off Isolation = 20Log10 (V_D/V_S), V_D = output. V_S = input to off switch.

Table 8. USB related AC electrical characteristics

Symbol		Test	conditions	ons Va				Value			
	Parameter	V _{CC} (V)		Т	A = 25°	C	-40 to 85°C		Unit		
		VCC (V)		Min	Тур	Max	Min	Max			
t _{SK(0)}	Channel-to-channel skew	3.0 to 3.6	C _L =10pF		26				ps		
t _{SK(P)}	Skew of opposite transition of the same output	3.0 to 3.6	C _L =10pF		60				ps		
ТJ	Total jitter	3.0 to 3.6	$R_L = 50Ω$ $C_L = 10pF$, $t_R = t_F = 750ps$ at 480Mbps		130				ps		



5 Test circuits

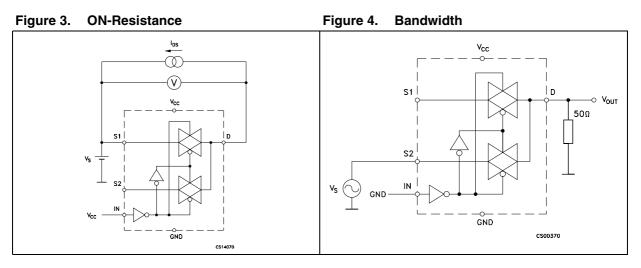
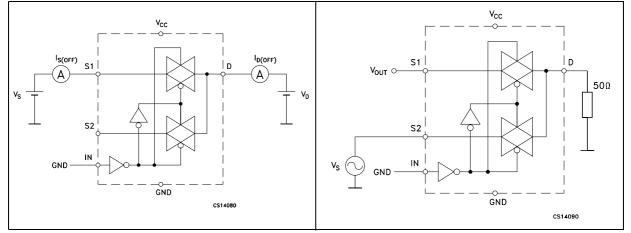




Figure 6. Channel to channel crosstalk





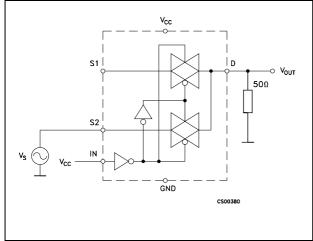
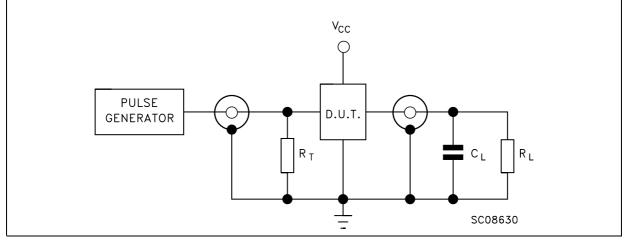


Figure 8. Test circuit



- *Note:* 1 $C_L = 5/35$ pF or equivalent: (includes jig capacitance)
 - 2 $R_L = 50\Omega$ or equivalent
 - 3 $R_T = Z_{OUT}$ of pulse generator (typically 50 Ω)



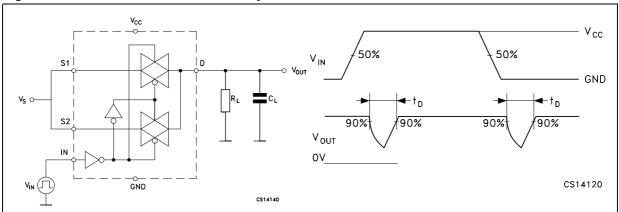
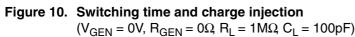


Figure 9. Break-before-make time delay



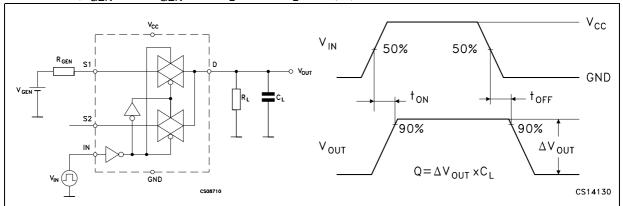
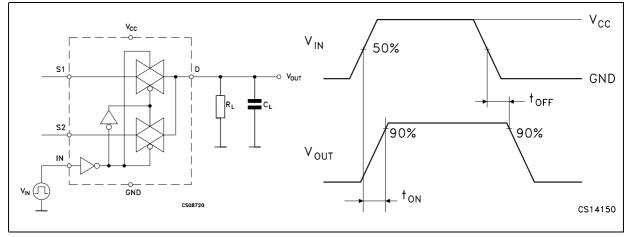


Figure 11. Turn ON, turn OFF delay time



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6 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

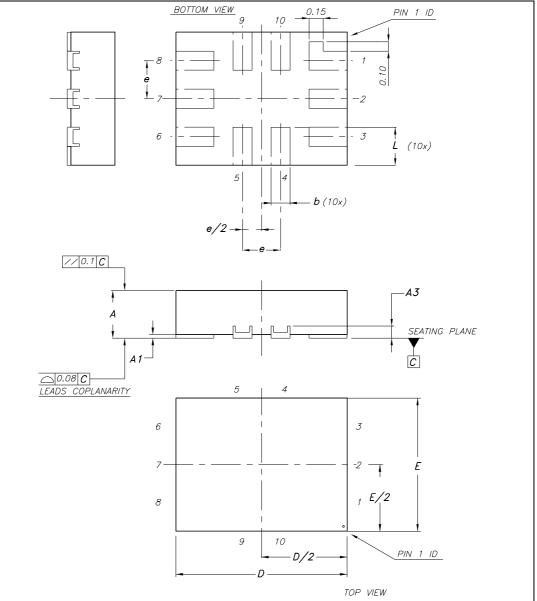


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Table 9. QFN	10L(1.8x1.4) Mechical data
	mm

ref.	mm			inch		
Ter.	Nom	Min	Max	Nom	Min	Max
A	0.50	0.45	0.55	0.020	0.017	0.021
A1	0.02	0	0.05	0.001	0	0.002
A3	0.127			0.005	0	0
b	0.20	0.15	0.25	0.007	0.006	0.010
D	1.80	1.70	1.90	0.070	0.066	0.074
E	1.40	1.30	1.50	0.055	0.051	0.059
е	0.40			0.015		
L	0.40	0.30	0.50	0.015	0.011	0.020

Figure 12. Package dimension



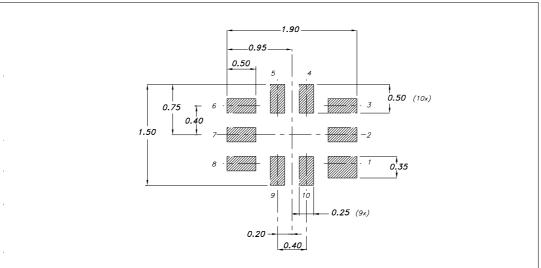
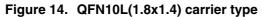
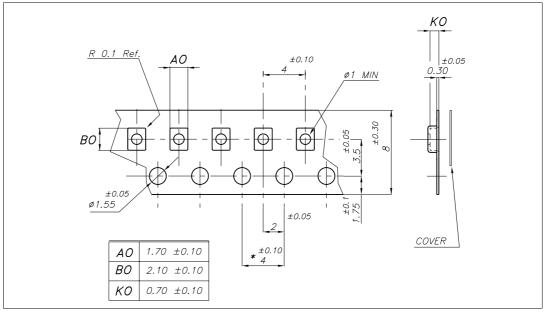


Figure 13. QFN10L(1.8x1.4) Foot print recommendation





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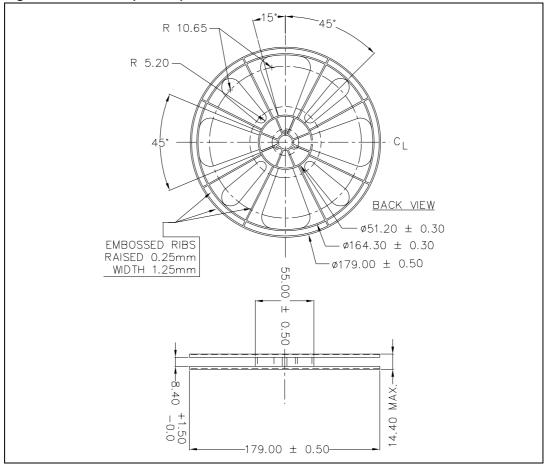


Figure 15. QFN10L(1.8x1.4) Reel information



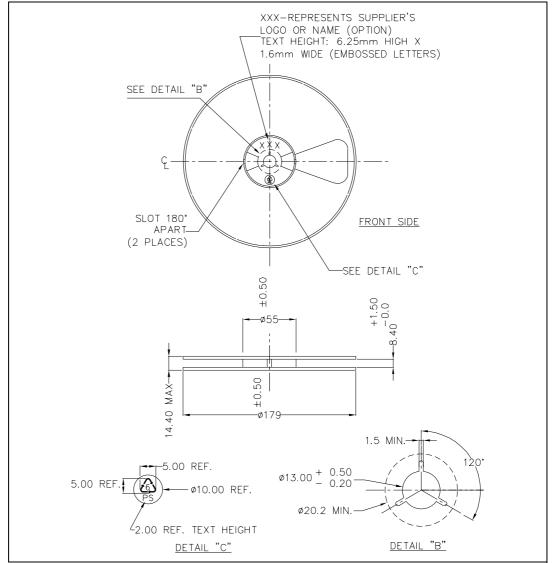


Figure 16. QFN10L(1.8x1.4) Reel information



7 Revision history

Table 10. Revision history

Date	Revision	Changes
04-Dec-2006	1	First release



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